Nickel Foam Supported Porous Copper Oxide Catalysts with Noble Metallike Activity for Aqueous Phase Reactions

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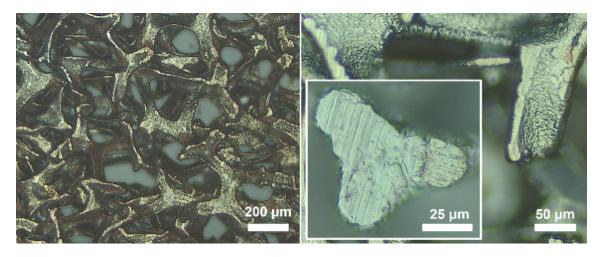


Figure S1. Optical microscope image of untreated nickel foam as purchased from MTI Corporation; < 20% porosity, 80 μm thick.

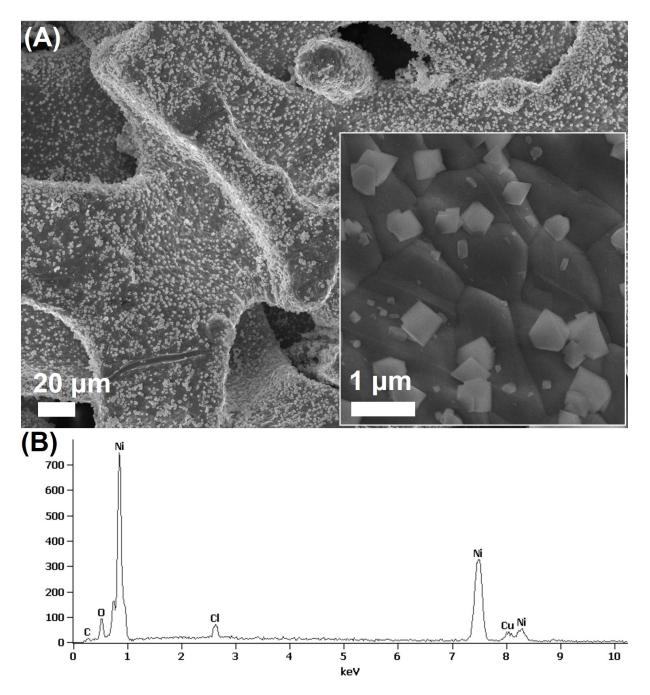


Figure S2: SEM micrograph (A) and EDS spectrum (B) of Cu/Ni_{200} .

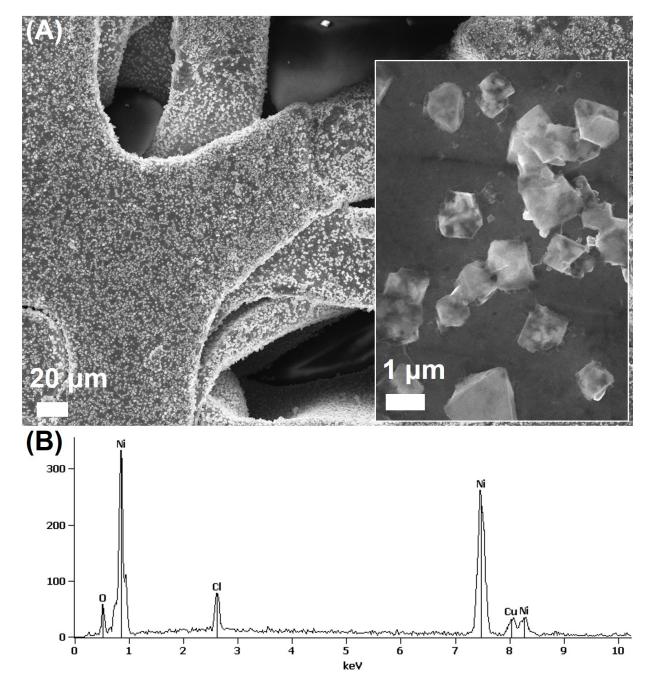


Figure S3: SEM micrograph (A) and EDS spectrum (B) of Cu/Ni_{300} .

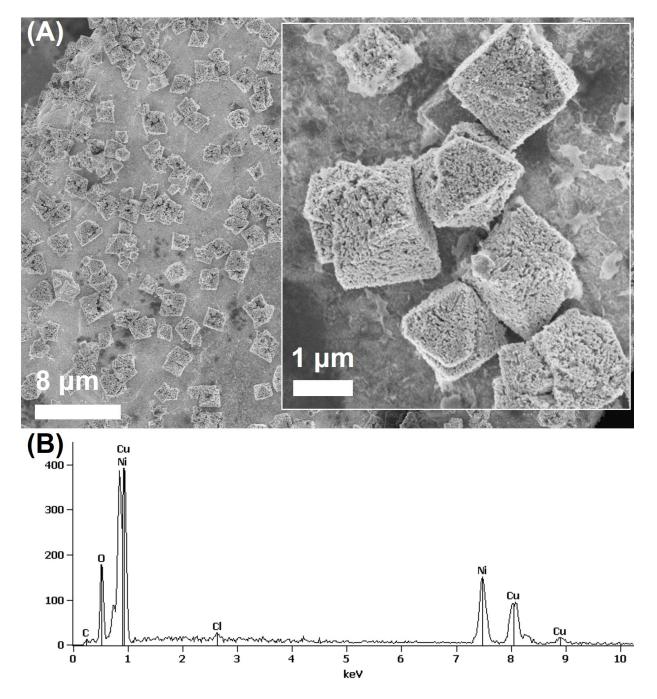


Figure S4: SEM micrograph (A) and EDS spectrum (B) of Cu/Ni₄₀₀.

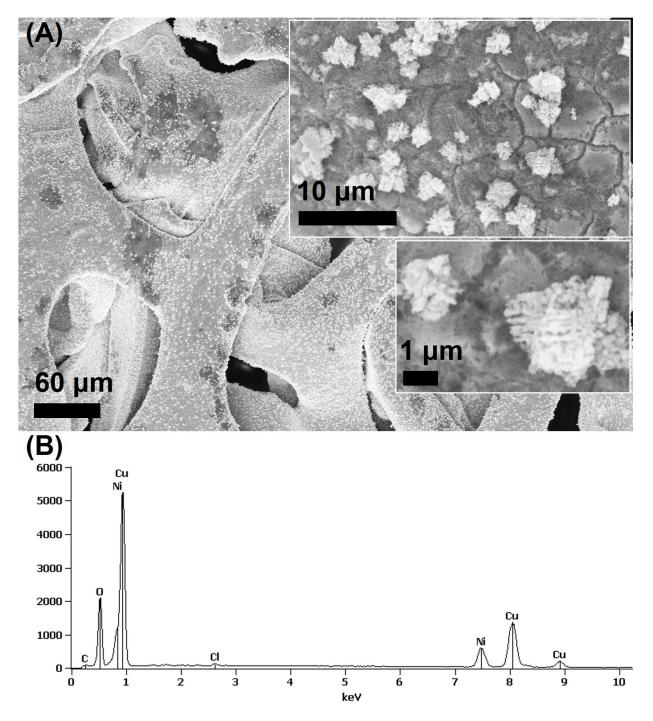


Figure S5: SEM micrograph (A) and EDS spectrum (B) of Cu/Ni₅₀₀.

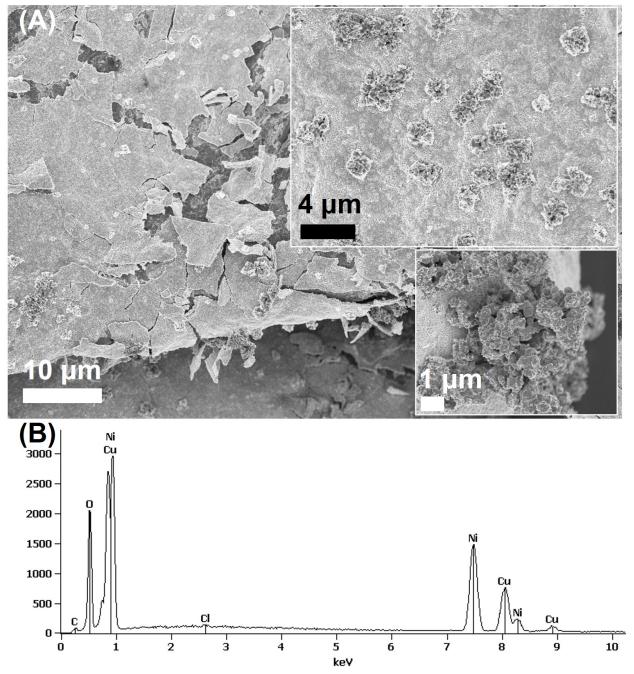


Figure S6: SEM micrograph (A) and EDS spectrum (B) of Cu/Ni_{600} .

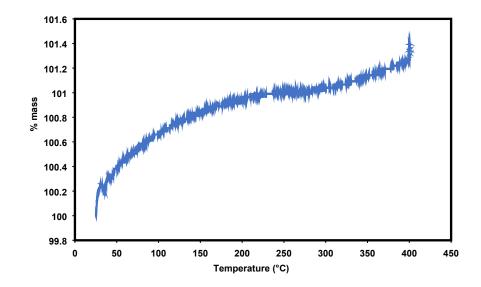


Figure S7: Thermogravimetric curve for bare Ni foam conducted under air with a heating rate of 5 °C/minute with a 60-minute hold at 400 °C. *Increased mass indicates formation of nickel oxide on surface.*

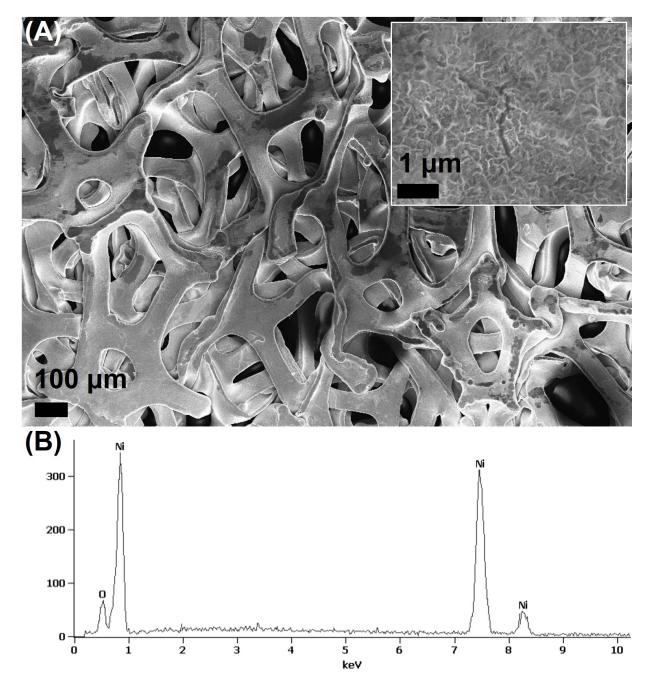


Figure S8: SEM micrograph (A) and EDS spectrum (B) of Ni_{400} .

Material	Proposed composition	Atom % Cl (SEM-EDS)	Atom % Cu (SEM-EDS)	Observed Cu:Cl ratio	Expected Cu:Cl ratio
Cu/Ni ₂₀₀	Cu ₂ (OH) ₃ Cl	3.1 ± 0.4	7.0 ± 0.6	2.3(±0.5):1	2:1
Cu/Ni ₃₀₀	Cu ₂ (OH) ₃ Cl	5.5 ± 0.4	13.3 ± 1.2	2.4(±0.4):1	2:1
Cu/Ni ₄₀₀	CuO	0.8 ± 0.2	23.8 ± 1.4	29.8(±9.2):1	1:0
Cu/Ni ₅₀₀	CuO	0.4 ± 0.0	29.1 ± 0.4	72.8(±1.0):1	1:0
Cu/Ni ₆₀₀	CuO	0.4 ± 0.0	26.6 ± 0.4	66.5(±1.0):1	1:0

Table S1: Cu:Cl atomic ratios for each Cu/Ni_x species as obtained from SEM-EDS.

XPS Analysis and Procedure: For Ni 2p, O 1s and C 1s, ranges for binding energy (BE) values and total number of sweeps were as follows: 848–890 eV, 50–75 sweeps; 525–540 eV, 5–10 sweeps; 278–295 eV, 5–10 sweeps; respectively. The average analysis time for one sample spot was 1.5-2 h. For nickel compounds the spin-orbit splitting of the $2p_{3/2}$ and $2p_{1/2}$ was, in most cases large enough, so that only the more intense $2p_{3/2}$ signal needed be considered. However, overlap of the high BE satellite band from Ni(OH)₂ with the $2p_{1/2}$ metal line, which was composed of an asymmetric main line and contributions from plasmon loss structure, could create some challenges in locating appropriate spectral background. The spectrometer dispersion was later adjusted to give a B.E. value of 932.63 eV for metallic Cu $2p_{3/2}$. Charge neutralization was deemed to have been fully achieved by monitoring the C 1s signal for adventitious carbon. A sharp main peak with no lower B.E. structure is generally expected. Instrument base pressure was 7×10^{-9} mbar. High-resolution spectra were obtained using an analysis area of $\approx 300 \times 700 \,\mu$ m and a 20-eV pass energy. This pass energy corresponds to Ag $3d_{5/2}$ full width at half maximum (FWHM) of 0.55 eV (Ref. 48).

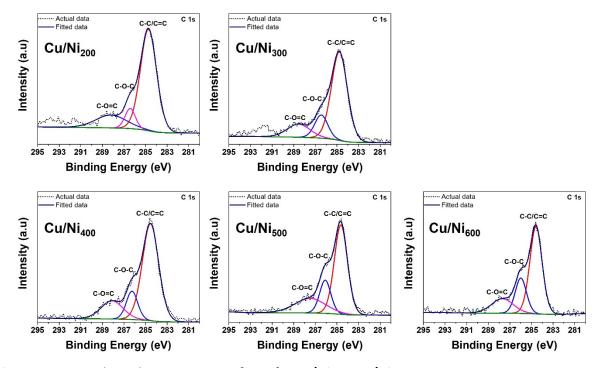


Figure S9: X-ray photoelectron spectra of C 1s for Cu/Ni₂₀₀ – Cu/Ni₆₀₀.

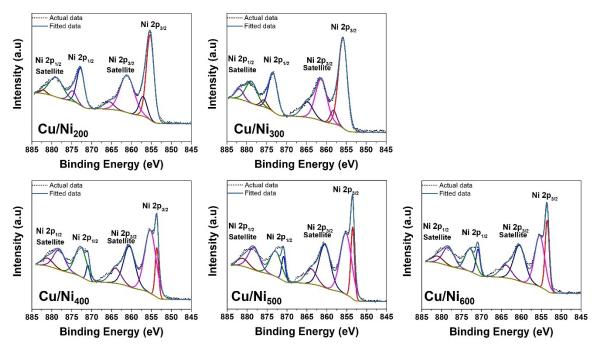


Figure S10: X-ray photoelectron spectra of Ni 2p for Cu/Ni₂₀₀ – Cu/Ni₆₀₀.

Sample	C 1s	O 1s	Ni 2p	Cu 2p	Cl 2p
Cu/Ni ₂₀₀	20.22	50.01	17.75	5.49	6.53
Cu/Ni ₃₀₀	21.99	38.65	13.67	9.52	12.99
Cu/Ni ₄₀₀	18.57	48.02	21.81	10.09	1.51
Cu/Ni ₅₀₀	15.39	45.57	24.31	14.73	-
Cu/Ni ₆₀₀	14.97	47.15	21.15	16.74	-
Ni ₄₀₀	20.08	50.6	29.32	-	-

Table S2: Atomic concentration of elements obtained from survey spectrum.

Sample	Ni 2p _{3,}	_{/2} peak		Ni 2p _{3/2} satellite peak		Ni 2p _{1/2} peak		₂ satellite ak
	1 st peak	2 nd peak	1 st peak	2 nd peak	1 st peak	2 nd peak	1 st peak	2 nd peak
	B.E.	B.E.	B.E.	B.E.	B.E.	B.E.	B.E.	B.E.
Cu/Ni ₂₀₀	855.31	857.01	861.1	865.68	872.8	874.79	878.93	882.16
Cu/Ni ₃₀₀	855.84	864.81	861.3	858.21	873.42	881.82	878.84	875.71
Cu/Ni ₄₀₀	853.62	860.53	855.26	864.02	870.94	878.13	872.73	881.13
Cu/Ni ₅₀₀	853.51	860.49	855.19	864.00	870.87	878.28	872.84	881.11
Cu/Ni ₆₀₀	853.51	860.46	855.37	863.93	870.87	878.27	872.84	881.04
Ni ₄₀₀	854.11	860.84	856.33	864.52	871.91	878.94	872.93	881.74

Table S3: Ni 2p binding energy.

Table S4: C 1s binding energy values of the prepared catalyst samples.

Sample		C 1s						
	C-C/C=C	C-O=C	C-O-C					
	B.E.	B.E.	B.E.					
Cu/Ni ₂₀₀	284.79	288.30	286.43					
Cu/Ni ₃₀₀	284.80	288.59	286.36					
Cu/Ni ₄₀₀	284.80	288.21	286.48					
Cu/Ni ₅₀₀	284.79	287.56	286.23					
Cu/Ni ₆₀₀	284.80	287.89	286.20					
Ni ₄₀₀	284.8	288.06	286.79					

Table S5: O1s fitted spectra for $Cu/Ni_{200} - Cu/Ni_{600}$ – see Fig. 4B in manuscript. O 1s binding energy values for the prepared catalyst samples.

Sample	e O _L			O _H		Ον		Oc	
	B.E.	Atomic %	B.E.	Atomic %	B.E.	Atomic %	B.E.	Atomic %	
Cu/Ni ₂₀₀	-	-	531.01	83.04	-	-	532.53	16.96	
Cu/Ni ₃₀₀	-	-	531.19	89.52	-	-	532.79	10.48	
Cu/Ni ₄₀₀	529.45	48.03	-	-	531.05	42.21	532.56	9.76	
Cu/Ni ₅₀₀	529.33	69.45	-	-	531.00	22.40	532.51	8.14	
Cu/Ni ₆₀₀	529.40	65.17	-	-	531.10	29.89	532.7	4.94	

Sample		Cu 2p _{3/2}		Cu 2p _{3/2} satellite peak				
	1 st peak	Atomic %	2 nd peak	Atomic %	1 st peak	Atomic %	2 nd peak	Atomic %
	B.E.		B.E.		B.E.		B.E.	
Cu/Ni ₂₀₀	934.65	58.40	-	-	943.32	24.00	940.64	17.60
Cu/Ni ₃₀₀	934.73	57.97	-	-	943.32	24.54	940.61	17.49
Cu/Ni ₄₀₀	934.95	21.15	933.46	40.48	943.51	12.83	940.95	25.54
Cu/Ni ₅₀₀	935.11	19.69	933.36	41.11	943.59	11.05	940.99	28.16
Cu/Ni ₆₀₀	935.20	18.90	933.47	42.85	943.73	9.76	941.18	28.46

Table S6: Cu2p fitted spectra for $Cu/Ni_{200} - Cu/Ni_{600}$ – see Fig. 4C in manuscript. Cu2p binding energy values for the prepared catalyst samples.

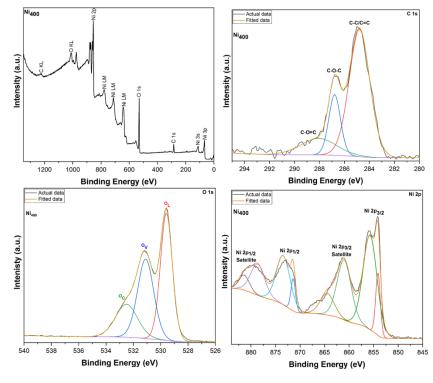


Figure S11: Survey scan (A) and high-resolution spectra of C 1s (B), O 1s (C), and Ni 2p (D) for Ni₄₀₀.

The C 1s XPS spectrum for **Ni**₄₀₀ indicates the presence of three different species at different BE values. Three different BE values of high-resolution C 1s spectrum obtained by deconvoluting it for three different peaks taking adventitious carbon (C-C/C=C at 284.80 eV) as a reference. The most intense peak observed at 284.80 eV was attributed to the C-C/C=C, while the other peaks visible at 288.06 eV and 286.79 eV were assigned to C-O=C and C-O-C respectively [1]. The deconvoluted O 1s spectrum BE values at 529.58 eV, 531.10 eV, and 532.5 eV were assigned to lattice oxygen (O²⁻), oxygen vacancy (O_V), and adsorbed oxygen (O_c) respectively. The BE values for O 1s at 529.58 eV suggested the presence of metal oxygen bonds [2].

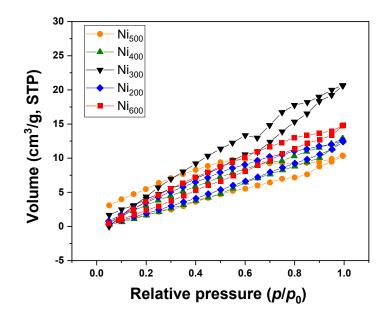


Figure S12: N_2 adsorption-desorption isotherms for the bare Ni_x samples.

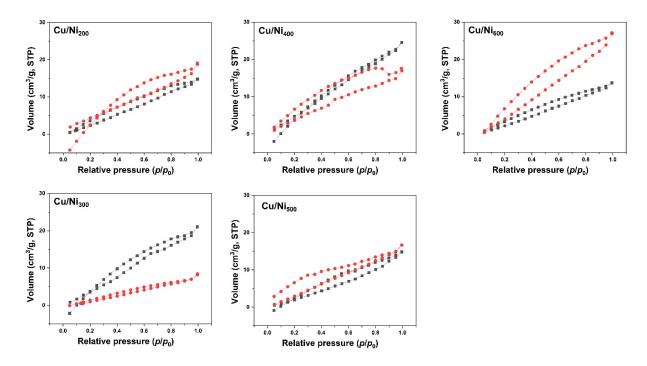


Figure S13: N_2 adsorption-desorption isotherms for each Cu/Ni_x sample.

Material	Surface area of Ni _x (m ² g ⁻¹)	(i) Surface area of Cu/Ni _x (m ² g ⁻¹)	(ii) Surface area of Cu/Ni _x (m ² g ⁻¹)	Avg. Surface area of Cu@/Ni _x (m ² g ⁻¹)	Δ Surface Area [Avg. Cu/Ni _x - Ni _x](m ² g ⁻¹)	Normalized Surface area for Cu catalyst component (See Table 1 - manuscript) (m ² g ⁻¹)
Cu/Ni ₂₀₀	19.62	29.76	19.66	24.71	5.09	202.41 ± 119.21
Cu/Ni ₃₀₀	21.70	24.38	35.93	30.15	8.45	184.42 ± 126.05
Cu/Ni ₄₀₀	16.52	34.70	28.58	31.64	15.12	842.09 ± 170.27
Cu/Ni ₅₀₀	14.28	20.01	27.01	23.51	9.22	689.35 ± 261.70
Cu/Ni ₆₀₀	19.36	21.22	46.72	33.97	14.61	885.90 ± 319.32

Table S8: Cu/Ni_x surface areas obtained from BET method.

Catalysis Trials

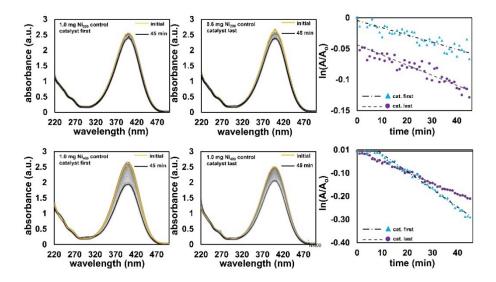


Figure S14: Catalytic reduction of **4NP** (0.39 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Ni**₂₀₀ [1] and **Ni**₄₀₀ (*bottom*) with addition order of catalyst first. Change of absorbance was monitored at 1 min intervals.

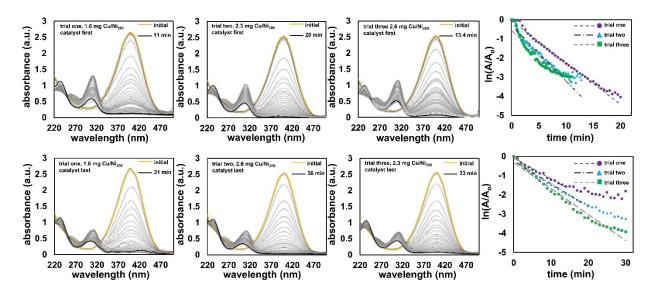


Figure S15: Catalytic reduction of **4NP** (0.39 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₂₀₀ with catalyst order of addition first and last (*bottom*). Change of absorbance was monitored at 0.5, 0.2, and 0.2 min intervals for catalyst first (left to right) and 1 min intervals for catalyst last trials. Perturbation from evolved H₂ bubbles was normalized to a flat baseline.

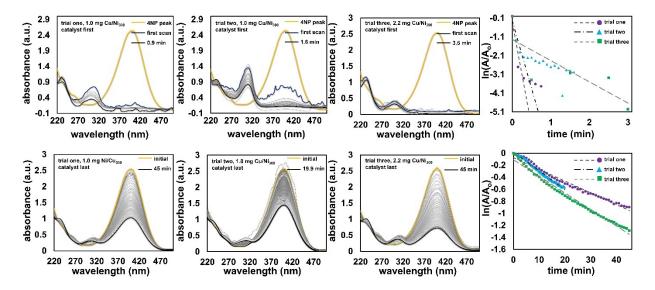


Figure S16: Catalytic reduction of **4NP** (0.39 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni₃₀₀** with catalyst order of addition first and last (*bottom*). Change of absorbance was monitored at 0.1, 0.1, and 0.5 min intervals for catalyst first (left to right) and 1, 0.1, and 1 min intervals for catalyst last trials (left to right). Perturbation from evolved H₂ bubbles was normalized to a flat baseline.

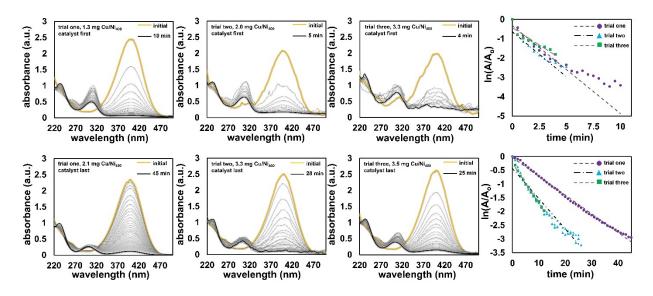


Figure S17: Catalytic reduction of **4NP** (0.39 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni₄₀₀** with catalyst order of addition first and last (*bottom*). Change of absorbance was monitored 0.5 min intervals for catalyst first and 1 min intervals for catalyst last trials. Perturbation from evolved H₂ bubbles was normalized to a flat baseline.

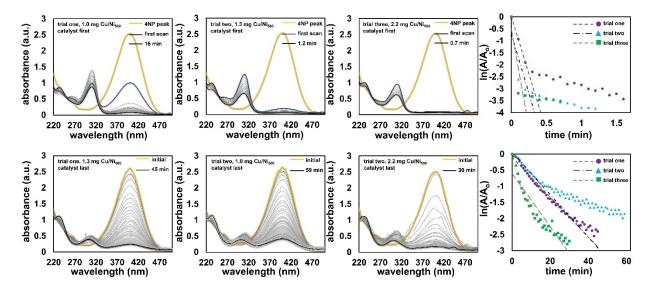


Figure S18: Catalytic reduction of **4NP** (0.39 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₅₀₀ with catalyst order of addition first and last (*bottom*). Change of absorbance was monitored at 0.1 min intervals for catalyst first and 1 min intervals for catalyst last trials. Perturbation from evolved H₂ bubbles was normalized to a flat baseline.

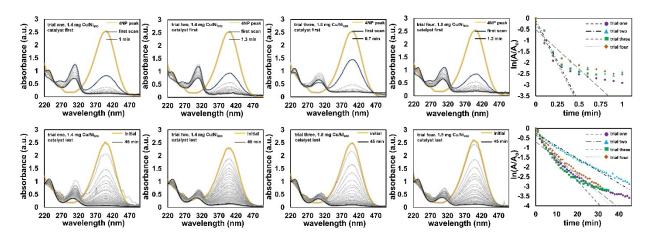


Figure S19: Catalytic reduction of **4NP** (0.39 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₆₀₀ with catalyst order of addition first and last (*bottom*). Change of absorbance was monitored at 0.1 min intervals for catalyst first and 1 min intervals for catalyst last trials. Perturbation from evolved H₂ bubbles was normalized to a flat baseline.

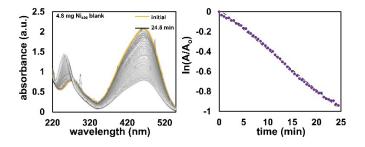


Figure S20: Catalytic reduction of **MO** (0.34 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Ni**₄₀₀. Change of absorbance was monitored at 0.5 min intervals.

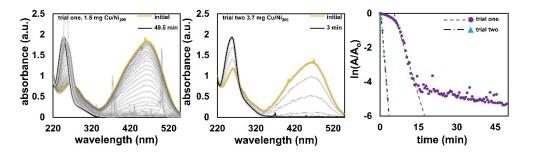


Figure S21: Catalytic reduction **MO** (0.34 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₂₀₀ with catalyst added last. Change of absorbance was monitored at 0.5 min intervals.

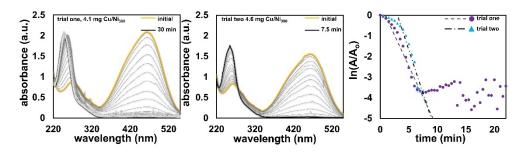


Figure S22: Catalytic reduction **MO** (0.34 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni₃₀₀** with catalyst added last. Change of absorbance was monitored at 0.5 min intervals.

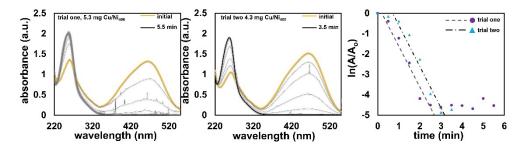


Figure S23: Catalytic reduction **MO** (0.34 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni₄₀₀** with catalyst added last. Change of absorbance was monitored at 0.5 min intervals.

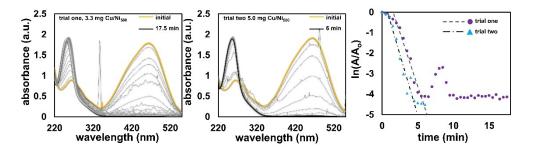


Figure S24: Catalytic reduction **MO** (0.34 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₅₀₀ with catalyst added last. Change of absorbance was monitored at 0.5 min intervals.

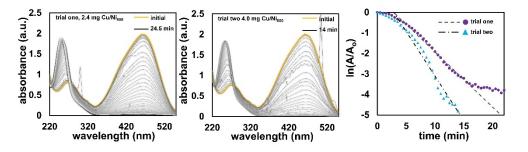


Figure S25: Catalytic reduction **MO** (0.34 μ mol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₆₀₀ with catalyst added last. Change of absorbance was monitored at 0.5 min intervals.

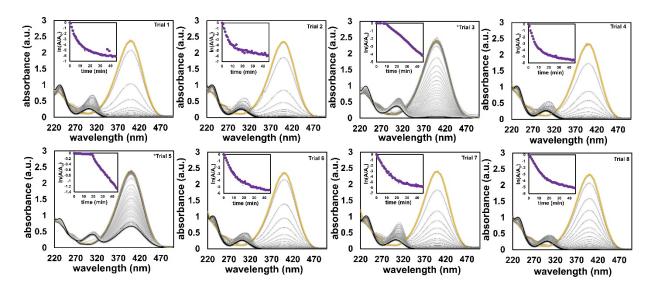


Figure S26: Catalytic recycling trials for the reduction of **4NP** (0.39 µmol) in 3 mL DIW with 0.2 mmol NaBH₄ with **Cu/Ni**₅₀₀ with catalyst added last. of **4NP** \rightarrow **4AP*** in DIW with excess NaBH₄. Recycling trials 1,2,4,6-8 were rinsed thoroughly with DIW, trials 3 and 5, were only cleaned with one quick DIW rinse which resulted in reduced rate and a notable induction period. Change of absorbance was monitored at 0.1 min intervals.

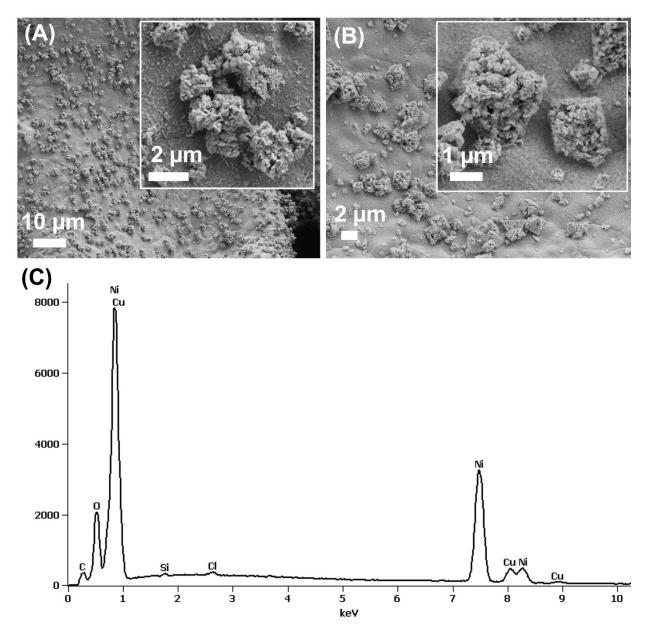


Figure S27: SEM micrograph of post-mortem Cu/Ni_{400} (A) and Cu/Ni_{500} (B), and EDS spectrum (C) of Cu/Ni_{400} post-mortem.

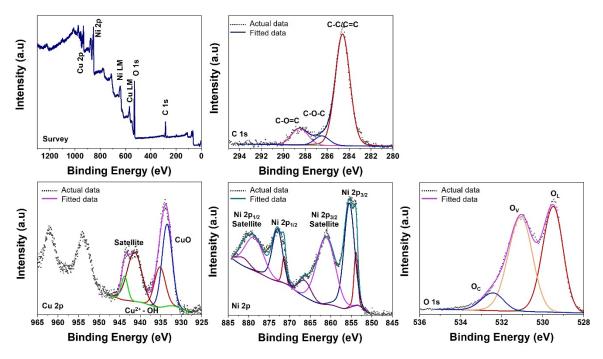


Figure S28: X-ray photoelectron spectra for Cu/Ni₄₀₀ post-mortem.

Table S9: Atomic concentration of elements obtained from survey spectrum for Cu/Ni₄₀₀ post-mortem sample.

Sample	C 1s	0 1s	Ni 2p	Cu 2p	Cl 2p	N 1s	B 1s	Na 1s
Spent Cu/Ni ₄₀₀ At.%	31.79	40.45	15.39	8.21	1.79	0.58	1.79	0

References:

- 1. Landoulsi, J., et al.Organic adlayer on inorganic materials: XPS analysis selectivity to cope with adventitious contamination. *Applied Surface Science* **2016**, 383, 71-83.
- 2. Biesinger, M.C.Advanced analysis of copper X-ray photoelectron spectra. *Surface and Interface Analysis* **2017**, 49, 1325-1334.